

## PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1  
 Stylesheet Version v1.2

EPAS ID: PAT4712179

|                                                                                                                                                                                                 |                                          |
|-------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|------------------------------------------|
| <b>SUBMISSION TYPE:</b>                                                                                                                                                                         | NEW ASSIGNMENT                           |
| <b>NATURE OF CONVEYANCE:</b>                                                                                                                                                                    | ASSIGNMENT                               |
| <b>CONVEYING PARTY DATA</b>                                                                                                                                                                     |                                          |
| <b>Name</b>                                                                                                                                                                                     | <b>Execution Date</b>                    |
| DAVID LYSACEK                                                                                                                                                                                   | 11/09/2017                               |
| VIOLA KRIZAKOVA                                                                                                                                                                                 | 11/09/2017                               |
| JAN SIK                                                                                                                                                                                         | 11/09/2017                               |
| <b>RECEIVING PARTY DATA</b>                                                                                                                                                                     |                                          |
| <b>Name:</b>                                                                                                                                                                                    | SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC |
| <b>Street Address:</b>                                                                                                                                                                          | 5005 E. MCDOWELL RD.                     |
| <b>Internal Address:</b>                                                                                                                                                                        | MD A700                                  |
| <b>City:</b>                                                                                                                                                                                    | PHOENIX                                  |
| <b>State/Country:</b>                                                                                                                                                                           | ARIZONA                                  |
| <b>Postal Code:</b>                                                                                                                                                                             | 85008                                    |
| <b>PROPERTY NUMBERS Total: 1</b>                                                                                                                                                                |                                          |
| <b>Property Type</b>                                                                                                                                                                            | <b>Number</b>                            |
| Application Number:                                                                                                                                                                             | 15827882                                 |
| <b>CORRESPONDENCE DATA</b>                                                                                                                                                                      |                                          |
| <b>Fax Number:</b>                                                                                                                                                                              |                                          |
| <i>Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.</i> |                                          |
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| <b>Correspondent Name:</b>                                                                                                                                                                      | SEMICONDUCTOR COMPONENTS INDUSTRIES, LLC |
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| <b>Address Line 4:</b>                                                                                                                                                                          | PHOENIX, ARIZONA 85008                   |
| <b>ATTORNEY DOCKET NUMBER:</b>                                                                                                                                                                  | ONS02498US                               |
| <b>NAME OF SUBMITTER:</b>                                                                                                                                                                       | BECKY NEWNAM                             |
| <b>SIGNATURE:</b>                                                                                                                                                                               | /Becky Newnam/                           |
| <b>DATE SIGNED:</b>                                                                                                                                                                             | 11/30/2017                               |
| <b>Total Attachments: 2</b>                                                                                                                                                                     |                                          |
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| source=ONS02498US_20171130_Assignment#page2.tif                                                                                                                                                 |                                          |

## ASSIGNMENT & AGREEMENT

For good and valuable consideration, the receipt and sufficiency of which is hereby acknowledged, we,

| Name            | of (City and State OR Country) |
|-----------------|--------------------------------|
| David LYSACEK   | Zasova Czech Republic          |
| Viola KRIZAKOVA | Studenka Czech Republic        |
| Jan SIK         | Čeladná Czech Republic         |

agree to sell, assign, and transfer, and do hereby sell, assign, and transfer to Semiconductor Components Industries, LLC, a limited liability company of the State of Delaware, having its principal office in Phoenix, State of Arizona, United States of America, and its successors, assigns, and legal representatives ("SCI"), the entire right, title, and interest in and to the inventions and discoveries as described, illustrated, and/or claimed in

**Title: METHOD OF FORMING A MULTILAYER STRUCTURE FOR REDUCING DEFECTS IN SEMICONDUCTOR DEVICES AND STRUCTURE**

**Attorney Docket No.: ON502498US**

**Serial No.: 15/827882**

**Filing Date: November 30, 2017**

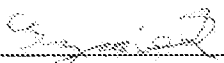
together with the entire right, title, and interest in and to the above listed application(s), and in and to any and all provisional, non-provisional, divisional, continuation, continuation-in-part, international, foreign, and any and all other applications related thereto, and also including any and all grants, issuances, letters patent, reissues, reexaminations, renewals, priority rights, and priority claims related to any of the foregoing, and any and all rights to collect past damages for infringement of any of the foregoing (the "Patent Rights").

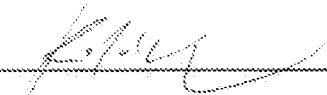
We further authorize SCI to apply for and hold and maintain the Patent Rights throughout the world directly in its own name or any other name which SCI deems appropriate in its sole discretion, and to claim the priority of the filing date of the above listed application(s).

We agree that, when requested, we will, without charge to SCI, sign all papers, take all rightful oaths, and do all acts which may be necessary, desirable, or convenient for securing, maintaining, and enforcing the Patent Rights in any and all countries and for vesting title thereto in SCI or its nominees.

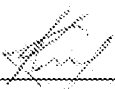
We represent and warrant that we have full right to convey the entire right, title and interest herein sold, assigned, and transferred, and that the Patent Rights hereby conveyed are free from all prior assignment, grant, mortgage, license, or other encumbrance to anyone other than SCI. We covenant and further warrant that we will not convey hereafter any part of the Patent Rights to anyone other than SCI or do any act whatsoever conflicting with this ASSIGNMENT & AGREEMENT.

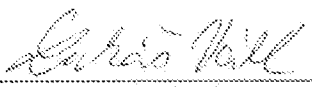
We hereby authorize SCI or anyone it may properly designate to insert in this ASSIGNMENT & AGREEMENT the filing date and serial number of the above listed application(s) when ascertained. More than one counterpart of this ASSIGNMENT & AGREEMENT may be executed, each of which will be deemed an original.

By (Inventor signature):   
David LYSACEK

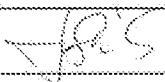
Witnessed by (Witness signature):   
Printed name of Witness: ROMAN KOLAR

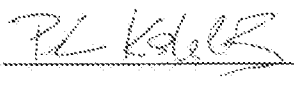
Signed and Witnessed on (date): 9-Nov-2017

By (Inventor signature):   
Viola KRIZAKOVA

Witnessed by (Witness signature):   
Printed name of Witness: LUKAS VALEK

Signed and Witnessed on (date): 9-NOV-2017

By (Inventor signature):   
Jan SIK

Witnessed by (Witness signature):   
Printed name of Witness: PETR KOSTELNYK

Signed and Witnessed on (date): 9-NOV-2017